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Date May 12, 2005
To United States Patent and Trademark Office

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From Gerald P. Parsons, Reg. No. 24,486
Total pages 5
Subject Application No.: 10/811,074
Your Ref. Conf. No.: 8070
Our Ref. SNDK.307US1

COMMISSIONER FOR PATENTS
P.O. BOX 1450
ALEXANDRIA, VA 22313-1450

Applicant: Feng Pan
Title: High Voltage Ripple Reduction and Substrate Protection
Application No.: 10/811,074
Filing Date: March 26, 2004
Conf. No.: 8070
Atty Docket No.: SNDK.307US1

ENCLOSED:

1. Transmittal Letter (1 page)
2. Power of Attorney by Assignee of Entire Interest (3 pages)

PAG/meb

Due Date: June 26, 2004
Transmission Date: May 12, 2005

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May 12, 2005

Commissioner For Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Re: Applicant: Feng Pan
Title: High Voltage Ripple Reduction and Substrate Protection
Application No.: 10/811,074 Filing Date: March 26, 2004
Examiner: Unassigned Group Art Unit: 2838
Docket No.: SNDK.307US1 Conf. No.: 8070

Dear Sir:

Transmitted herewith are the following documents in the above-identified application:

- (1) This Transmittal Letter (1 page); and
- (2) Power of Attorney by Assignee of Entire Interest (3 pages).

☒ No additional fee is required.

Certificate of Transmission Under 37 CFR 1.8

I hereby certify that this correspondence is being
facsimile transmitted to the United States Patent and
Trademark Office on May 12, 2005

Mary S. Bragg
Signature

Respectfully submitted,



Gerald P. Parsons
Reg. No. 24,486

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Feng Pan
Title: High Voltage Ripple Reduction and Substrate Protection
Application No.: 10/811,074 Filing Date: March 26, 2004
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Commissioner for Patents
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Alexandria, VA 22313-1450

POWER OF ATTORNEY BY ASSIGNEE OF ENTIRE INTEREST

Sir:

SanDisk Corporation, a Delaware corporation, hereby revokes all powers of attorney previously given and appoints the following attorneys specifically and solely to prosecute the above-identified application and to transact all business in the United States Patent and Trademark Office in connection therewith:

Gerald P. Parsons, Reg. No. 24,486
James S. Hsue, Reg. No. 29,545
K. Alison de Runtz, Reg. No. 37,119

Please direct all communications in connection with the above-identified patent application to:

Customer Number: 36257

Parsons Hsue & de Runtz LLP
655 Montgomery Street, Suite 1800
San Francisco, CA 94111
Telephone No.: (415) 318-1160
Fax No.: (415) 693-0194

Attorney Docket No.: SNDK.307US1

Application No.: 10/811,074

- 1 -

ASSIGNEE CERTIFICATION UNDER 37 CFR 3.73(B)

The undersigned hereby certifies that SanDisk Corporation is the assignee of the entire right, title and interest in the above-identified patent application by virtue of a chain of title from the inventor(s) to SanDisk Corporation, as shown by the attached copy of an Assignment from the inventor(s), which is being separately recorded.

Each of the undersigned is empowered to sign this certificate on behalf of SanDisk Corporation.

March 24, 2005
Date [Signature]
Name: Charles Van Orden
Title: Vice President and General Counsel

March 24, 2005
Date [Signature]
Name: Megan Comport
Title: Assistant Secretary, SanDisk Corp.

Attorney Docket No.: SNDK.307US1

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I, **Feng Pan** of San Jose, California, hereby sell, assign and transfer to SanDisk Corporation, a Delaware corporation, having a place of business at 140 Caspian Court, Sunnyvale, CA, 94089, its successors and assigns, the entire right, title and interest throughout the world in my invention in

HIGH VOLTAGE RIPPLE REDUCTION AND SUBSTRATE PROTECTION

for which I have filed a United States patent application on March 26, 2004, which now has Serial No. 10/811,074, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 24 day of March, 2005.


Feng Pan